HALOGEN

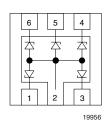
FREE

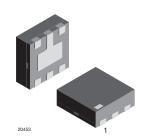
GREEN



Vishay Semiconductors

5-Line ESD Protection Diode Array in LLP75





MARKING (example only)



Dot = pin 1 marking XX = date code YY = type code (see table below)

DESIGN SUPPORT TOOLS

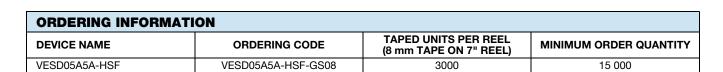
Models





FEATURES

- Ultra compact LLP75-6L package
- Low profile < 0.6 mm
- 5-line ESD protection
- Low leakage current $I_R < 0.1 \mu A$
- Low load capacitance C_D = 13 pF
- ESD immunity acc. IEC 61000-4-2 ± 15 kV contact discharge ± 15 kV air discharge
- Working voltage range V_{RWM} = 5 V
- e4 precious metal (e.g. Ag, Au, NiPd, NiPdAu) (no Sn)
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912



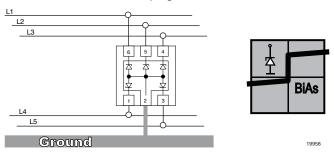
PACKAGE DA	TA									
DEVICE NAME	PACKAGE NAME	TYPE CODE	WEIGHT	MOLDING COMPOUND FLAMMABILITY RATING	MOISTURE SENSITIVITY LEVEL	SOLDERING CONDITIONS				
VESD05A5A-HSF	LLP75-6L	AR	4.2 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	Peak temperature max. 260 °C				

ABSOLUTE MAXI	MUM RATINGS VESD05A5A-HSF				
PARAMETER	TEST CONDITIONS			VALUE	UNIT
Peak pulse current	BiAs-mode: each input (pin 1 to pin 6) to ground (pin acc. IEC 61000-4-5; $t_p = 8/20 \mu s$; single shot	- I _{PPM}	2.5	Α	
	BiSy-mode: each input (pin 1 to pin 6) to any other input Pin 2 not connected. Acc. IEC 61000-4-5; $t_p = 8/20 \mu s$; sing		2.5	Α	
Pook pulso power	BiAs-mode: each input (pin 1 to pin 6) to ground (pin acc. IEC 61000-4-5; $t_p = 8/20 \mu s$; single shot	2);	- P _{PP}	33	W
Peak pulse power	BiSy-mode: each input (pin 1 - pin 6) to any other input Pin 2 not connected. Acc. IEC 61000-4-5; t_p = 8/20 μ s; sing	Грр	43	W	
ESD immunity	acc. IEC61000-4-2; 10 pulses	Contact discharge	- V _{ESD}	± 15	15 kV
LOD IIIIIIIIIIIII	BiAs-mode: each input (pin 1 to pin 6) to ground (pin 2)	Air discharge	VESD	± 15	kV
ESD immunity	acc. IEC 61000-4-2; 10 pulses BiSy-mode: each input (pin 1 to pin 6) to any other input pin.	Contact discharge	V _{ESD}	± 10	kV
LOD IIIIIIIIIIIII	Pin 2 not connected.	Air discharge	VESD	± 10	kV
Operating temperature	Junction temperature		T_J	-40 to +125	°C
Storage temperature			T _{STG}	-55 to +150	°C

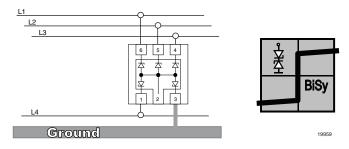


APPLICATION NOTE:

a. With the VESD05A5A-HSF 5 different signal or data lines can be clamped to ground. Due to the different clamping levels in forward and reverse direction the VESD05A5A-HSF clamping behavior is bidirectional and asymmetrical (BiAs).



b. If symmetrical clamping behaviour is required the VESD05A5A-HSF can also be used as a bidirectional symmetrical protection device protecting up to 4 lines. In this case pin no. 2 must not be connected.



PARAMETER	erwise specified) TEST CONDITIONS/REMARKS	SYMBOL	MIN.	TYP.	MAX.	UNIT
Protection paths	Number of lines which can be protected	N _{channel}	-	-	5	lines
Reverse stand-off voltage	Max. reverse working voltage	V _{RWM}	-	-	5	V
Reverse voltage	at I _R = 0.1 μA	V_{R}	5	-	-	V
Max. reverse current	at V _R = 5 V	I _R	-	< 0.01	0.1	μΑ
Reverse breakdown voltage	at I _R = 1 mA	V_{BR}	6	6.7	7.5	V
Reverse clamping voltage	at I _{PP} = 1 A	V_{C}	-	9	10	V
	at I _{PP} = I _{PPM} = 2.5 A	V _C	-	12	13	V
Forward clamping voltage	at I _{PP} = 1 A	V_{F}	-	2	2.5	V
	at I _{PP} = I _{PPM} = 2.5 A	V_{F}	-	3.2	4	V
12	at $V_R = 0 V$; $f = 1 MHz$	C _D	-	13	15	pF
Line capacitance	at V _R = 2.5 V; f = 1 MHz	C _D	-	8	-	pF

TYPICAL CHARACTERISTICS (T_{amb} = 25 °C, unless otherwise specified)

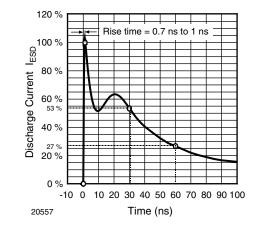


Fig. 1 - ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 Ω /150 pF)

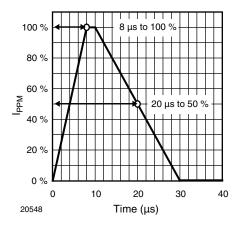


Fig. 2 - 8/20 µs Peak Pulse Current Wave Form acc. IEC 61000-4-5

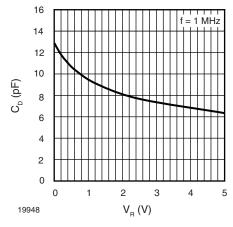


Fig. 3 - Typical Capacitance C_{D} vs. Reverse Voltage V_{R}

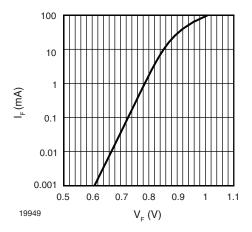


Fig. 4 - Typical Forward Current I_{F} vs. Forward Voltage V_{F}

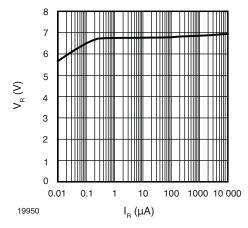


Fig. 5 - Typical Reverse Voltage V_R vs. Reverse Current I_R

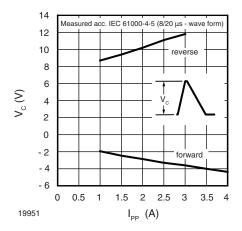


Fig. 6 - Typical Peak Clamping Voltage V_C vs. Peak Pulse Current I_{PP}



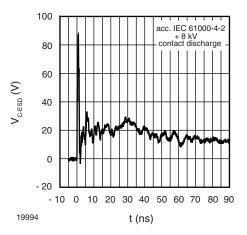


Fig. 7 - Typical Clamping Performance at + 8 kV Contact Discharge (acc. IEC 61000-4-2)

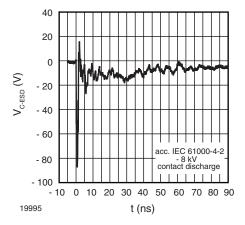


Fig. 8 - Typical Clamping Performance at - 8 kV Contact Discharge (acc. IEC 61000-4-2)

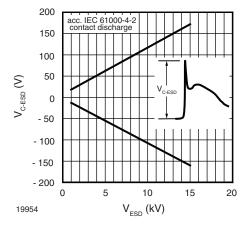
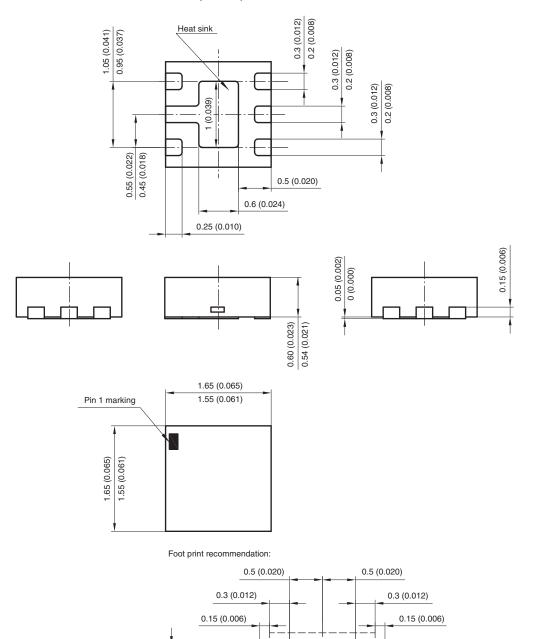


Fig. 9 - Typical max. Clamping Voltage at ESD Contact Discharge (acc. IEC 61000-4-2)

Solder resist mask

Solder pad

PACKAGE DIMENSIONS in millimeters (Inches): LLP75-6L



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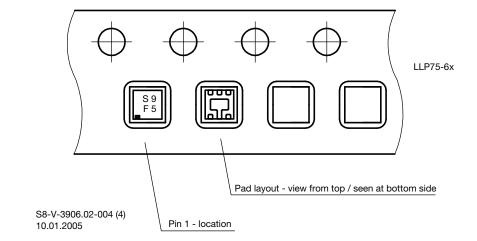
0.5 (0.020)

1 (0.039)

0.5 (0.020)

0.25 (0.010)







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